

SN54ALS874B, SN74ALS874B, SN74ALS876A SN74AS874, SN74AS876 DUAL 4-BIT D-TYPE EDGE-TRIGGERED FLIP-FLOPS

SDAS061C – APRIL 1982 – REVISED JANUARY 1995

- 3-State Buffer-Type Outputs Drive Bus Lines Directly
- Bus-Structured Pinout
- Choice of True or Inverting Logic
 - SN54ALS874B, SN74ALS874B, SN74AS874 Have True Outputs
 - SN74ALS876A, SN74AS876 Have Inverting Outputs
- Asynchronous Clear
- Package Options Include Plastic Small-Outline (DW) Packages, Plastic (FN) and Ceramic (FK) Chip Carriers, and Standard Plastic (NT) and Ceramic (JT) 300-mil DIPs

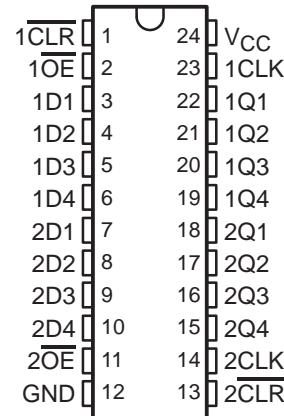
description

These dual 4-bit D-type edge-triggered flip-flops feature 3-state outputs designed specifically as bus drivers. They are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

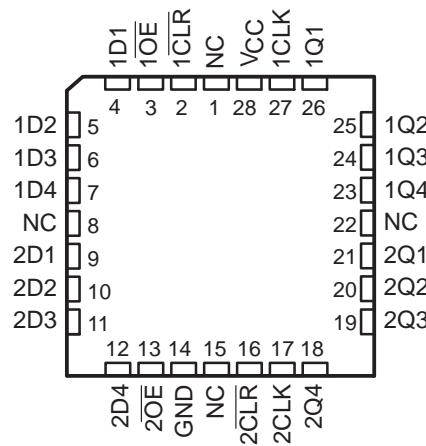
The edge-triggered flip-flops enter data on the low-to-high transition of the clock (CLK) input. The SN54ALS874B, SN74ALS874B, and SN74AS874 have clear (CLR) inputs and noninverting Q outputs. The SN74ALS876A and SN74AS876 have preset (PRE) inputs and inverting \bar{Q} outputs; taking PRE low causes the four Q or \bar{Q} outputs to go low independently of the clock.

The SN54ALS874B is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74ALS874B, SN74ALS876A, SN74AS874, and SN74AS876 devices are characterized for operation from 0°C to 70°C .

SN54ALS874B . . . JT PACKAGE
SN74ALS874B, SN74AS874 . . . DW OR NT PACKAGE
(TOP VIEW)

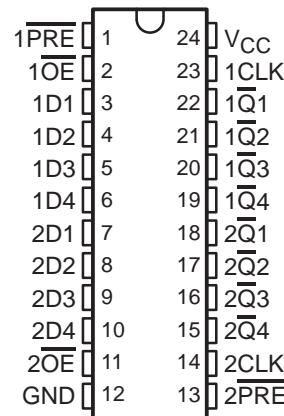


SN54ALS874B . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

SN74ALS876A, SN74AS876 . . . DW OR NT PACKAGE
(TOP VIEW)



**SN54ALS874B, SN74ALS874B, SN74ALS876A
SN74AS874, SN74AS876
DUAL 4-BIT D-TYPE EDGE-TRIGGERED FLIP-FLOPS**

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Function Tables

**SN54ALS874B, SN74ALS874B, SN74AS874
(each flip-flop)**

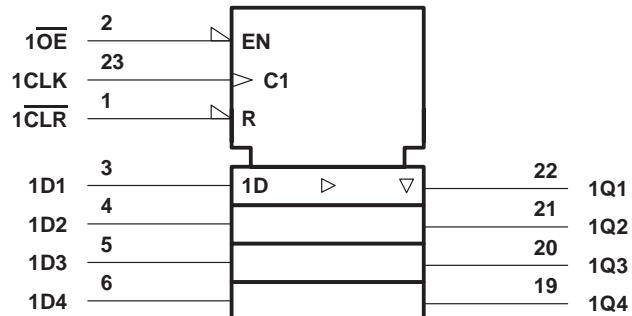
INPUTS				OUTPUT Q
\overline{OE}	\overline{CLR}	CLK	D	
L	L	X	X	L
L	H	↑	H	H
L	H	↑	L	L
L	H	L	X	Q_0
H	X	X	X	Z

**SN74ALS876A, SN74AS876
(each flip-flop)**

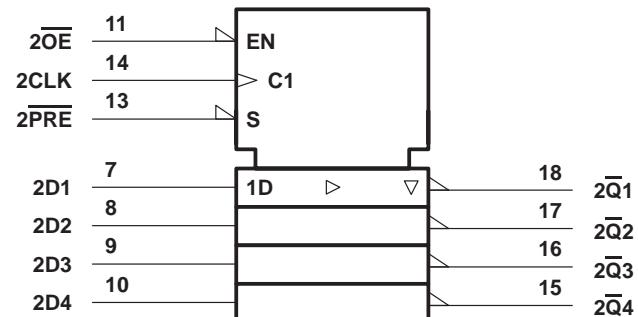
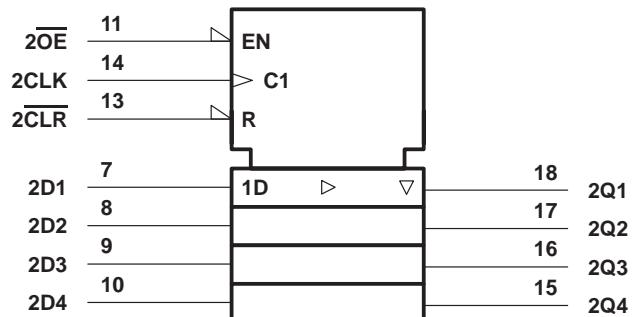
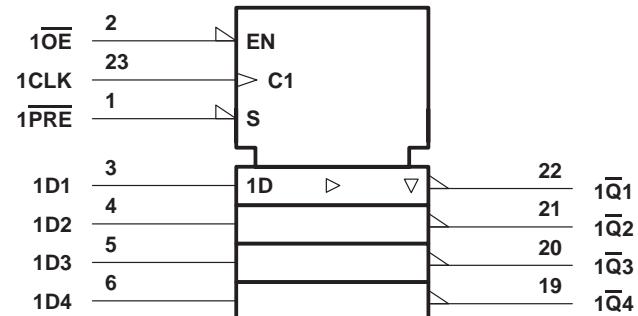
INPUTS				OUTPUT Q
\overline{OE}	\overline{PRE}	CLK	D	
L	L	X	X	L
L	H	↑	H	L
L	H	↑	L	H
L	H	L	X	\overline{Q}_0
H	X	X	X	Z

logic symbols[†]

SN54ALS874B, SN74ALS874B, SN74AS874



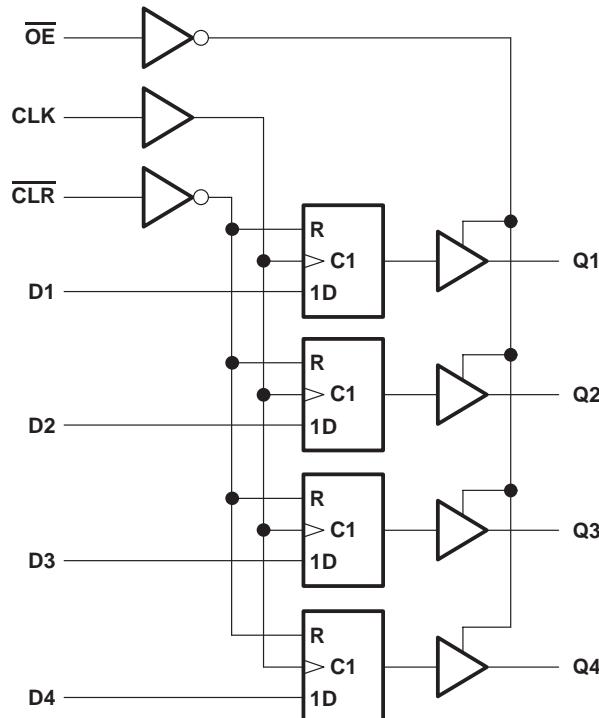
SN74ALS876A, SN74AS876



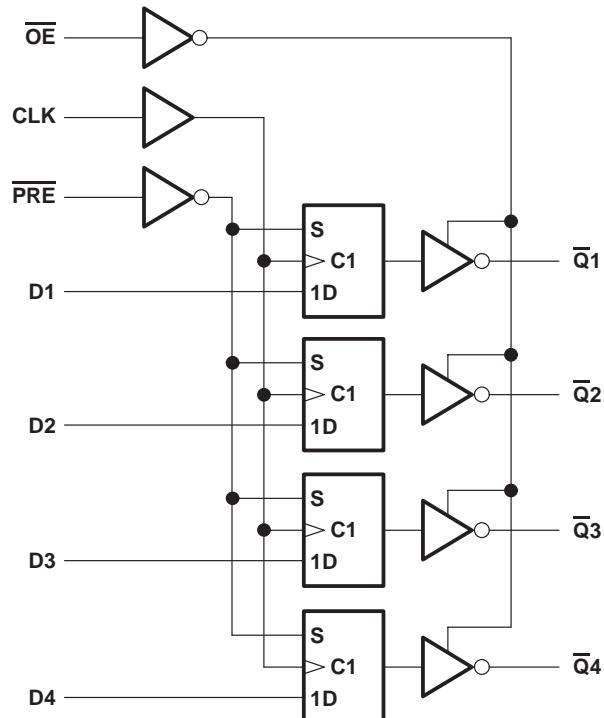
[†] These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the DW, JT, and NT packages.

logic diagrams (positive logic)

SN54ALS874B, SN74ALS874B, SN74AS874
 (each quad flip-flop)



SN74ALS876A, SN74AS876
 (each quad flip-flop)



Pin numbers shown are for the DW, JT, and NT packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V_{CC}	7 V
Input voltage, V_I	7 V
Voltage applied to a disabled 3-state output	5.5 V
Operating free-air temperature range, T_A : SN54ALS874B	-55°C to 125°C
SN74ALS874B, SN74ALS876A	0°C to 70°C
Storage temperature range	-65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

**SN54ALS874B, SN74ALS874B, SN74ALS876A
 SN74AS874, SN74AS876
 DUAL 4-BIT D-TYPE EDGE-TRIGGERED FLIP-FLOPS**

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recommended operating conditions

		SN54ALS874B			SN74ALS874B SN74ALS876A			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC}	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
V _{IH}	High-level input voltage	2			2			V
V _{IL}	Low-level input voltage			0.7			0.8	V
I _{OH}	High-level output current			-1			-2.6	mA
I _{OL}	Low-level output current			12			24	mA
f _{clock}	Clock frequency	0	25	0	0	25	30	MHz
t _w	Pulse duration	PRE or CLR low	15		10			ns
		CLK high	20		16.5			
		CLK low	20		16.5			
t _{su}	Setup time before CLK↑	Data	15		15			ns
		PRE or CLR inactive	15		10			
t _h	Hold time, data after CLK↑	4			0			ns
T _A	Operating free-air temperature	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	SN54ALS874B			SN74ALS874B SN74ALS876A			UNIT
		MIN	TYP†	MAX	MIN	TYP†	MAX	
V _{IK}	V _{CC} = 4.5 V, I _I = -18 mA			-1.2			-1.2	V
V _{OH}	V _{CC} = 4.5 V to 5.5 V, I _{OH} = -0.4 mA	V _{CC} – 2			V _{CC} – 2			V
	V _{CC} = 4.5 V	I _{OH} = -1 mA	2.4	3.3			2.4	
		I _{OH} = -2.6 mA					3.2	
V _{OL}	V _{CC} = 4.5 V	I _{OL} = 12 mA	0.25	0.4	0.25	0.4		V
		I _{OL} = 24 mA				0.35	0.5	
I _{OZH}	V _{CC} = 5.5 V, V _O = 2.7 V		20		20		20	μA
I _{OZL}	V _{CC} = 5.5 V, V _O = 0.4 V		-20		-20		-20	μA
I _I	V _{CC} = 5.5 V, V _I = 7 V		0.1		0.1		0.1	mA
I _{IH}	V _{CC} = 5.5 V, V _I = 2.7 V		20		20		20	μA
I _{IL}	V _{CC} = 5.5 V, V _I = 0.4 V		-0.2		-0.2		-0.2	mA
I _{O‡}	V _{CC} = 5.5 V, V _O = 2.25 V	-20	-112	-30	-112	-30	-112	mA
I _{CC}	'ALS874B	Outputs high	14	21	14	21		mA
		Outputs low	19	30	19	30		
		Outputs disabled	20	32	20	32		
	SN74ALS876A	Outputs high				14	21	mA
		Outputs low				18	29	
		Outputs disabled				20	31	

† All typical values are at V_{CC} = 5 V, T_A = 25°C.

‡ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}.

**SN54ALS874B, SN74ALS874B, SN74ALS876A
SN74AS874, SN74AS876**
DUAL 4-BIT D-TYPE EDGE-TRIGGERED FLIP-FLOPS

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switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$, $C_L = 50 \text{ pF}$, $R1 = 500 \Omega$, $R2 = 500 \Omega$, $T_A = \text{MIN to MAX}^\dagger$				UNIT	
			SN54ALS874B		SN74ALS874B			
			MIN	MAX	MIN	MAX		
f_{max}			25	30			MHz	
t_{PLH}	CLK	Any Q	4	18	4	14	ns	
t_{PHL}			4	16	4	14		
t_{PHL}	\overline{CLR}	Any Q	5	23	5	17	ns	
t_{PZH}	\overline{OE}	Any Q	4	24	4	18	ns	
t_{PZL}			4	21	4	18		
t_{PHZ}	\overline{OE}	Any Q	2	15	2	10	ns	
t_{PLZ}			3	22	3	12		

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$, $C_L = 50 \text{ pF}$, $R1 = 500 \Omega$, $R2 = 500 \Omega$, $T_A = \text{MIN to MAX}^\dagger$				UNIT	
			SN74ALS876A					
			MIN	MAX				
f_{max}			30				MHz	
t_{PLH}	CLK	Any \overline{Q}	4	14			ns	
t_{PHL}			4	14				
t_{PHL}	\overline{PRE}	Any \overline{Q}	6	19			ns	
t_{PZH}	\overline{OE}	Any \overline{Q}	4	18			ns	
t_{PZL}			4	18				
t_{PHZ}	\overline{OE}	Any \overline{Q}	2	10			ns	
t_{PLZ}			3	13				

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, V_{CC}	7 V
Input voltage, V_I	7 V
Operating free-air temperature range, T_A : SN74AS874, SN74AS876	0°C to 70°C
Storage temperature range	-65°C to 150°C

‡ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

**SN54ALS874B, SN74ALS874B, SN74ALS876A
 SN74AS874, SN74AS876
 DUAL 4-BIT D-TYPE EDGE-TRIGGERED FLIP-FLOPS**

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recommended operating conditions

		SN74AS874			SN74AS876			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC}	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
V _{IH}	High-level input voltage	2			2			V
V _{IL}	Low-level input voltage			0.8			0.8	V
I _{OH}	High-level output current			-15			-15	mA
I _{OL}	Low-level output current			48			48	mA
f _{clock}	Clock frequency	0	125	0	0	80	MHz	
t _w	Pulse duration	PRE or CLR low	2		4.5			ns
		CLK high	3		6.2			
		CLK low	4		6.2			
t _{su}	Setup time before CLK↑	Data	2		4.5			ns
		PRE or CLR inactive	4		5			
t _h	Hold time, data after CLK↑	1			2			ns
T _A	Operating free-air temperature	0	70	0	0	70	°C	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS			SN74AS874 SN74AS876		UNIT
	MIN	TYP†	MAX	MIN	TYP	
V _{IK}	V _{CC} = 4.5 V,	I _I = -18 mA			-1.2	V
V _{OH}	V _{CC} = 4.5 V to 5.5 V,	I _{OH} = -2 mA		V _{CC} - 2		V
	V _{CC} = 4.5 V,	I _{OH} = -15 mA		2.4	3.3	
V _{OL}	V _{CC} = 4.5 V,	I _{OL} = 48 mA		0.35	0.5	V
I _{OZH}	V _{CC} = 5.5 V,	V _O = 2.7 V		50	μA	
I _{OZL}	V _{CC} = 5.5 V,	V _O = 0.4 V		-50	μA	
I _I	V _{CC} = 5.5 V,	V _I = 7 V		0.1	mA	
I _{IH}	V _{CC} = 5.5 V,	V _I = 2.7 V		20	μA	
I _{IL}	D	V _{CC} = 5.5 V,	V _I = 0.4 V		-2	mA
	All others				-0.5	
I _O ‡	V _{CC} = 5.5 V,	V _O = 2.25 V		-30	-112	mA
I _{CC}	SN74AS874	V _{CC} = 5.5 V	Outputs high	82	133	mA
			Outputs low	92	149	
			Outputs disabled	100	160	
	SN74AS876	V _{CC} = 5.5 V	Outputs high	88	142	
			Outputs low	94	150	
			Outputs disabled	100	160	

† All typical values are at V_{CC} = 5 V, T_A = 25°C.

‡ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}.

**SN54ALS874B, SN74ALS874B, SN74ALS876A
SN74AS874, SN74AS876**
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switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$ $C_L = 50 \text{ pF},$ $R1 = 500 \Omega,$ $R2 = 500 \Omega,$ $T_A = \text{MIN to MAX}^\dagger$	UNIT	
			SN74AS874		
			MIN	MAX	
f_{max}			125		MHz
t_{PLH}	CLK	Any Q	3	8.5	ns
t_{PHL}			4	10.5	
t_{PHL}	\overline{CLR}	Any Q	4	9.5	ns
t_{PZH}	\overline{OE}	Any Q	2	7	ns
t_{PZL}			3	10.5	
t_{PHZ}	\overline{OE}	Any Q	2	6	ns
t_{PLZ}			2	7.5	

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$ $C_L = 50 \text{ pF},$ $R1 = 500 \Omega,$ $R2 = 500 \Omega,$ $T_A = \text{MIN to MAX}^\dagger$	UNIT	
			SN74AS876		
			MIN	MAX	
f_{max}			80		MHz
t_{PLH}	CLK	Any \overline{Q}	3	8.5	ns
t_{PHL}			4	10.5	
t_{PHL}	\overline{PRE}	Any \overline{Q}	4	9.5	ns
t_{PZH}	\overline{OE}	Any \overline{Q}	2	7	ns
t_{PZL}			3	11	
t_{PHZ}	\overline{OE}	Any \overline{Q}	2	7	ns
t_{PLZ}			2	7	

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

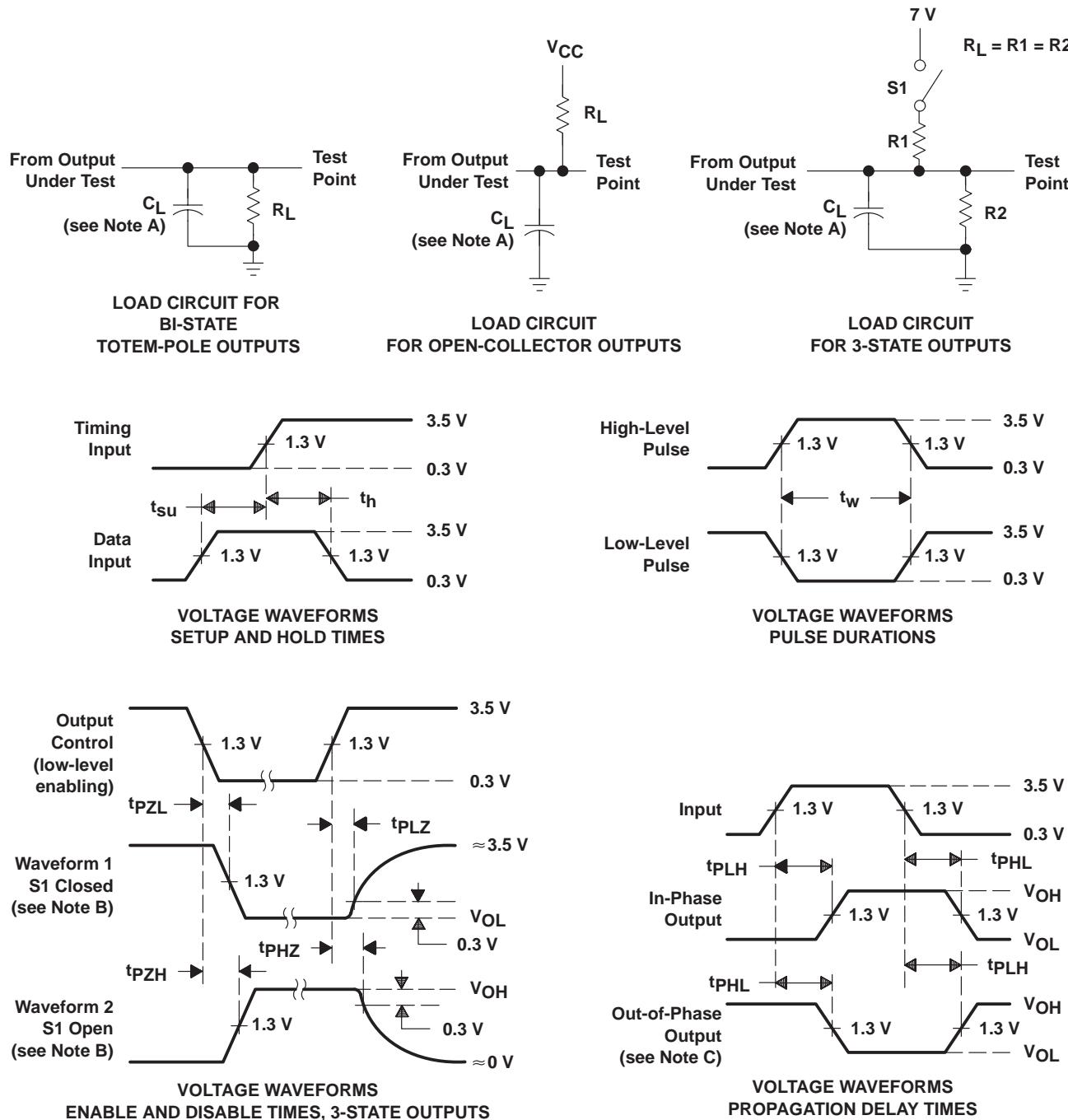
SN54ALS874B, SN74ALS874B, SN74ALS876A

SN74AS874, SN74AS876

DUAL 4-BIT D-TYPE EDGE-TRIGGERED FLIP-FLOPS

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PARAMETER MEASUREMENT INFORMATION
SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



NOTES: A. C_L includes probe and jig capacitance.

B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.

Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

C. When measuring propagation delay items of 3-state outputs, switch S1 is open.

D. All input pulses have the following characteristics: $PRR \leq 1 \text{ MHz}$, $t_r = t_f = 2 \text{ ns}$, duty cycle = 50%.

E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
84010013A	ACTIVE	LCCC	FK	28	1	None	Call TI	Level-NC-NC-NC
8401001KA	OBsolete	CFP	W	24		None	Call TI	Call TI
8401001LA	ACTIVE	CDIP	JT	24	1	None	Call TI	Level-NC-NC-NC
SN54ALS874BJT	ACTIVE	CDIP	JT	24	1	None	Call TI	Level-NC-NC-NC
SN74ALS874BDW	ACTIVE	SOIC	DW	24	25	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/Level-1-235C-UNLIM
SN74ALS874BDWR	ACTIVE	SOIC	DW	24	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/Level-1-235C-UNLIM
SN74ALS874BNSR	ACTIVE	SO	NS	24	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/Level-1-235C-UNLIM
SN74ALS874BNT	ACTIVE	PDIP	NT	24	15	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74ALS876ADW	ACTIVE	SOIC	DW	24	25	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/Level-1-235C-UNLIM
SN74ALS876ADWR	ACTIVE	SOIC	DW	24	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/Level-1-235C-UNLIM
SN74ALS876ANT	ACTIVE	PDIP	NT	24	15	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74AS874DW	ACTIVE	SOIC	DW	24	25	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/Level-1-235C-UNLIM
SN74AS874DWR	ACTIVE	SOIC	DW	24	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/Level-1-235C-UNLIM
SN74AS874NT	ACTIVE	PDIP	NT	24	15	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74AS876DW	ACTIVE	SOIC	DW	24	25	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/Level-1-235C-UNLIM
SN74AS876DWR	ACTIVE	SOIC	DW	24	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/Level-1-235C-UNLIM
SN74AS876NT	ACTIVE	PDIP	NT	24	15	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SNJ54ALS874BFK	ACTIVE	LCCC	FK	28	1	None	Call TI	Level-NC-NC-NC
SNJ54ALS874BJT	ACTIVE	CDIP	JT	24	1	None	Call TI	Level-NC-NC-NC

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBsolete: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - May not be currently available - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

Note: Not yet available Lead (Pb-Free).

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder

temperature.

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Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
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